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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/884,906	06/21/2001	Tae-Ho Yoon	05823.0204	4767
22852	7590 04/01/2004		EXAMINER	
FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER			TSOY, ELENA	
LLP 1300 I STREE	ET. NW	ART UNIT	PAPER NUMBER	
WASHINGTON, DC 20005			1762	
		DATE MAILED: 04/01/2004		

Please find below and/or attached an Office communication concerning this application or proceeding.

				AS
		Application No.	Applicant(s)	
		09/884,906	YOON ET AL	
Office Action Summary		Examiner	Art Unit	
		Elena Tsoy	1762	
Period fo	The MAILING DATE of this communic or Reply	ation appears on the cove	r sheet with the correspondence	ce address
THE I - External after - If the - If NO - Failur - Any r	ORTENED STATUTORY PERIOD FO MAILING DATE OF THIS COMMUNIC asions of time may be available under the provisions of SIX (6) MONTHS from the mailing date of this communication period for reply specified above is less than thirty (30) period for reply is specified above, the maximum stature to reply within the set or extended period for reply we reply received by the Office later than three months after the patent term adjustment. See 37 CFR 1.704(b).	CATION.  f 37 CFR 1.136(a). In no event, how nication.  days, a reply within the statutory miutory period will apply and will expire rill, by statute, cause the application is	ever, may a reply be timely filed  nimum of thirty (30) days will be considered  SIX (6) MONTHS from the mailing date of the of become ABANDONED (35 U.S.C. § 13	this communication.
1)[	Responsive to communication(s) file	d on <u>23 February 2004</u> .		
2a) <u></u> □	This action is <b>FINAL</b> . 2	b)☐ This action is non-f	inal.	
3)□ Dispositi	Since this application is in condition closed in accordance with the praction of Claims			
4) 🖂	Claim(s) 1,2,5-14 is/are pending in the	ne application.		
	4a) Of the above claim(s) is/are	e withdrawn from conside	ration.	
5)	Claim(s) is/are allowed.			
6) 🖂	Claim(s) 1,2,5-14 is/are rejected.			
7)	Claim(s) is/are objected to.			ì
8) 🗌	Claim(s) are subject to restrict	ion and/or election require	ement.	
Applicat	ion Papers			1
,	The specification is objected to by the			
10)	The drawing(s) filed on is/are: a			
	Applicant may not request that any obje			
11)	The proposed drawing correction filed			caminer.
40)	If approved, corrected drawings are requested to		ction.	
,	The oath or declaration is objected to	by the Examiner.		
	under 35 U.S.C. §§ 119 and 120		5110000440()(1)(0	
· —	Acknowledgment is made of a claim t	for foreign priority under 3	5 U.S.C. § 119(a)-(d) or (f).	
a)				
	1. Certified copies of the priority of			
	2. Certified copies of the priority of			1
* (	3.☐ Copies of the certified copies of application from the Internation attached detailed Office action	ational Bureau (PCT Rule	17.2(a)).	ional Stage
14) 🗌 /	Acknowledgment is made of a claim fo	r domestic priority under	35 U.S.C. § 119(e) (to a provis	sional application).
	a)  The translation of the foreign land  Acknowledgment is made of a claim for			
Attachmen	-			
2) Notice	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PT mation Disclosure Statement(s) (PTO-1449) Pa	· —	Interview Summary (PTO-413) Page Notice of Informal Patent Application Other:	1

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#### Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on February 23, 2004 has been entered.

## Response to Amendment

2. Amendment filed on February 23, 2004 has been entered. Claims 3 and 4 have been canceled. Claims 1, 2, 5-14 are pending in the application.

# Specification

3. Objection to the disclosure because of the informalities has been withdrawn due to amendment.

# Claim Objections

4. Objection to claims 8 and 13 because of the informalities has been withdrawn due to amendment.

# Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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6. Claims 1, 5, 6, 9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Garrett (US 6,437,026) in view of Ueno et al (US 4,606,930) and Gaku et al (US 4,904,760).

Garrett discloses a method of making a base formulation of EMC by forming a homogeneous mixture (See column 4, lines 7-11) by blending an epoxy resin (See column 3, lines 3-11), hardeners (See column 3, lines 11-18), catalysts (promoters) (See column 3, lines 53-58), silica filler having particle size of 0.5-40 microns and other fillers such as glass (See column 2, lines 56-67). Silane coupling agents may be used in the EMC formulation (See column 3, lines 28-38). It is well known in the art that silane coupling agents improve adhesion of silica to epoxy resin since the silane coupling agents are known to form chemical bonds between silica and epoxy resin (See specification, pages 1 and 2).

Garrett fails to teach that silica surface can be modified by plasma polymerization coating with a monomer such as pyrrole to improve adhesion of silica to epoxy resin (Claim 1).

Ueno et al teach that treating the surface of reinforcing fillers such as glass fibers, carbon fibers, alumina fibers, steel fibers, aramic fibers (See column 1, lines 11-14) by coating the glass fibers using plasma polymerization of a monomer such as <u>pyrrole</u>, quinoline, etc. (See column 2, lines 30-53) can be used to improve adhesion of glass fibers to thermosetting resins (See column 2, lines 20-24), e.g. <u>epoxy resins</u> (See column 2, line 66) by introducing functional groups to the surface (See column 2, lines 59-60).

Ueno et al does not expressly show that reinforcing fillers include silica glass fibers or silica. Gaku et al teach that glass fibers suitable for the use as reinforcing fillers in thermosetting resins (See column 1, lines 8-10) include silica glass fibers (See column 9, lines 57-68).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have treated silica of Garrett using plasma polymerization of pyrrole with the expectation

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of providing silica with the desired improved adhesiveness to epoxy resin, since Ueno et al teach that plasma treating of reinforcing fillers such as glass fibers improves adhesiveness to epoxy resin, and Gaku et al teach that glass fibers suitable for the use as reinforcing fillers in thermosetting resins include silica glass fibers.

As to claim 9, it is the Examiner's position that the plasma polymerization coating would be effective to enhance the flexural strength of the EMC of Garrett in view of Ueno et al and Gaku et al since it is produced by a method identical or substantially identical processes to that of claimed invention.

7. Claims 2, 10, 11, 14 are rejected under 35 U.S.C. 103(a) as being unpatentable over Garrett (US 6,437,026) in view of Ueno et al (US 4,606,930) and Gaku et al (US 4,904,760), further in view of Nakayama et al (US 4,619,861).

Garrett in view of Ueno et al and Gaku et al fails to teach that the method comprises the steps of charging silica into a plasma polymerization reactor, followed by vacuuming to  $1x10^{-3}$  torr; introducing the monomer and rotating the reactor at 1-50 rpm at plasma polymerization conditions: plasma powder (10-40 W), gas pressure (40-50 mtorr) and treatment time (20-40 seconds) (Claim 2).

Nakayama et al teach that a plasma polymerization of monomers such as quinoline (See column 3, line 62) for introducing functional groups to the particle surface can be carried out by charging particles to be coated into a plasma polymerization reactor followed by vacuuming the reactor to  $1 \times 10^{-2}$  torr or more (See column 5, lines 22-23); introducing the monomer such as quinoline (See column 3, line 62) and rotating the reactor at 20-70 rpm (See column 5, lines 19-44).

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It would have been obvious to one of ordinary skill in the art at the time the invention was made to have carried out a plasma polymerization of monomers such as pyrrole, quinoline in Garrett in view of Ueno et al and Gaku et al on silica surface by charging silica into a plasma polymerization reactor, followed by vacuuming the reactor to  $1x10^{-2}$  torr or more, introducing the monomer and rotating the reactor at 20-70 rpm with the expectation of providing the silica surface with desired functional groups, as taught by Nakayama et al.

As to the power of 10-40 W and treatment time, it is well known in the art that power level and treatment time are result-effective parameters in plasma polymerization coating process.

It is held that it is not inventive to discover the optimum or workable ranges of result-effective variables by routine experimentation. In re Antonie, 559 F.2d 618, 195 USPQ 6 (CCPA 1977). See also In re Boesch, 617 F.2d 272, 205 USPQ 215 (CCPA 1980).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have determined the optimum values of the relevant polymerization coating process parameters (including claimed power level of 10-40 W and claimed treatment time of 20-40 seconds) in a plasma polymerization process of Garrett in view of Ueno et al and Gaku et al in view of Nakayama et al through routine experimentation in the absence of a showing of criticality.

8. Claims 7, 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Garrett (US 6,437,026) in view of Ueno et al (US 4,606,930) and Gaku et al (US 4,904,760), further in view of Emler et al (US 4,690,107).

Garrett in view of Ueno et al and Gaku et al fails to teach that the method further comprises introducing the homogeneous mixture into the mold (Claim 7) such as silicone rubber mold (Claim 8).

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Emler et al teach that reinforced epoxy mass can be molded using a silicone rubber mold (See column 8, lines 4-46).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have used a silicone rubber mold for molding a homogeneous epoxy resin mixture of Garrett in view of Ueno et al and Gaku et al since Emler et al teach that reinforced epoxy mass can be molded using a silicone rubber mold.

9. Claims 12, 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Garrett (US 6,437,026) in view of Ueno et al (US 4,606,930) and Gaku et al (US 4,904,760), further in view of Nakayama et al (US 4,619,861), and further in view of Emler et al (US 4,690,107).

Garrett in view of Ueno et al and Gaku et al in view of Nakayama et al fails to teach that the method further comprises introducing the homogeneous mixture into the mold (Claim 12) such as silicone rubber mold (Claim 13).

Emler et al teach that reinforced epoxy mass can be molded using a silicone rubber mold (See column 8, lines 4-46).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to have used a silicone rubber mold for molding a homogeneous epoxy resin mixture of Garrett in view of Ueno et al and Gaku et al in view of Nakayama et al since Emler et al teach that reinforced epoxy mass can be molded using a silicone rubber mold.

#### Response to Arguments

10. Applicant's arguments with respect to claims 1, 2, 5-14 have been considered but are moot in view of the new ground(s) of rejection.

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### Conclusion

11. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Elena Tsoy whose telephone number is (571) 272-1429. The examiner can normally be reached on Mo-Thur. 9:00-7:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Shrive Beck can be reached on (571) 272-1415. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

ETSOY

Elena Tsoy Examiner Art Unit 1762

March 29, 2004